

Express Mail Mailing Label: EV 385 256 475 US
Title: MULTILAYERED COPPER STRUCTURE FOR
IMPROVING ADHESION PROPERTY

Inventors: Tue Nguyen

Application No.: Unassigned

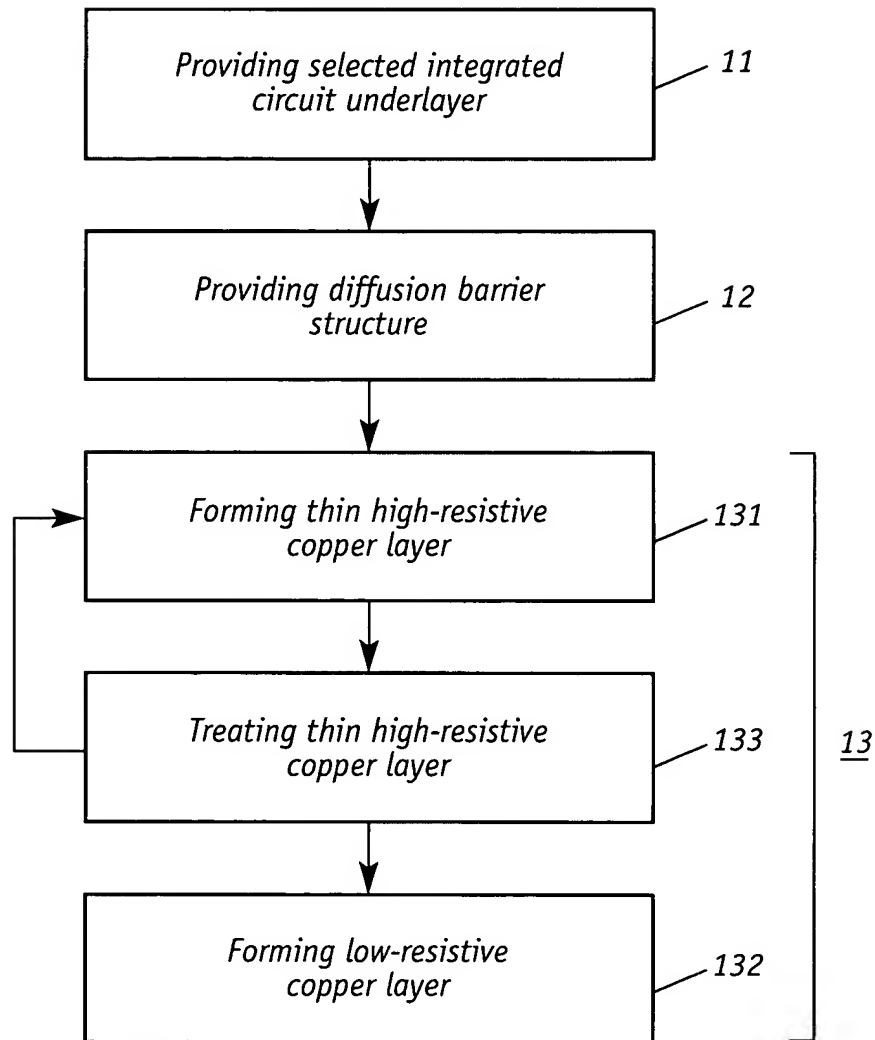
Docket No.: TEGL-01175US2

Attorney: Charles H. Jew

Filing Date: Filed Herewith

Telephone No. (415) 362-3800

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**FIG. 1**

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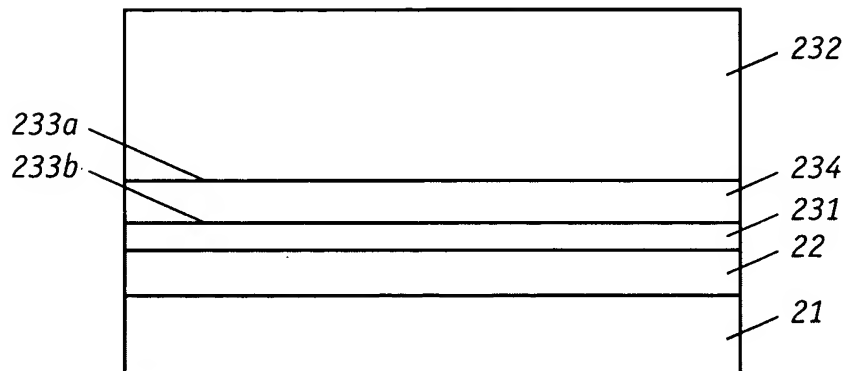


FIG. 2

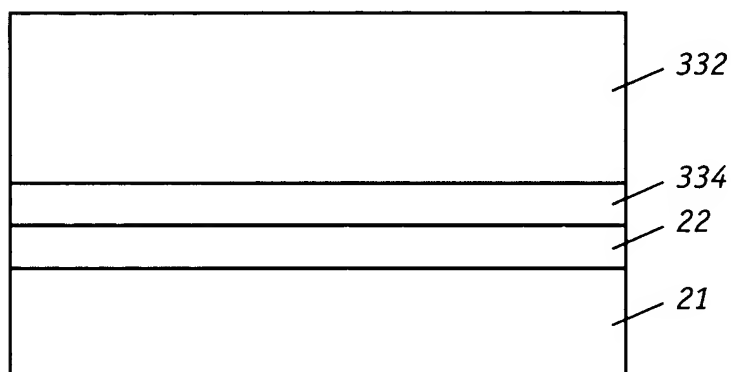


FIG. 3